

SID

Factory: Rot am See

Article:

725

ML4

Provided:

Kracht, Enrico

Customer:

Date:

20.04.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	A00 B00
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	340		2	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		3	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		4	
C-RS-FR4-ML-0.51mm-105+105-TG150-HF	50200884	105	L2		
		510		5	
		105	L3		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	340		6	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		7	
A-RS-FR4-Prepreg-7628-TG150-HF	50200643	0		8	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	9	

Thickness after Pressing

B00:

1440 µm

Tol+:

155 µm

Tol-:

155 µm

Dmax:

1595 µm

Dmin:

1285 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

1550 µm

Tol+:

155 µm

Tol-:

155 µm

Dmax:

1705 µm

Dmin:

1395 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

1436 µm

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